(1,00mm) .03937"
MB1 SERIES

# MIN EDCECARD SOCKE WTHCUDES 

Mates with:
(0,80mm) .031" PCB,
( $1,60 \mathrm{~mm}$ ) . 062 " PCB

## SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?MB1
Insulator Material:
Black LCP
Contact Material: BeCu

## Plating:

Sn or Au over $50 \mu$ " $(1,27 \mu \mathrm{~m}) \mathrm{Ni}$ Operating Temp Range:
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Insertion Depth: $(5,26 \mathrm{~mm})$
.207" to ( $6,10 \mathrm{~mm}$ ) .240" RoHS Compliant:
Yes
Processing:
Lead-Free Solderable:
Yes
SMT Lead Coplanarity:
(0,10mm) .004" max (20-30)
$(0,15 \mathrm{~mm}) .006 \mathrm{max}(40-50)$

## Important Note

Samtec recommends that pads on the mating board be Gold plated.

Note: Other Gold plating options available Contact Samtec.

## Note:

Some sizes, styles and options are non-standard, non-returnable.


## ALSO AVALIABIF

## Flex Card System

- 2 mm (.0787") (FCT/EMT Series) and 껜 .050" (1,27mm) (FCF/EMF Series) systems
- Vertical and horizontal
- Header with snap-on card guides for design flexibility
- Elevated design now available
- PCMCIA (PCMT/PCMS Series) Compact Flash (CFT/CFS Series) compatible applications available
- Ideal for multiple add-on cards
- Solder locks for mechanical stability
- Any size from 40 to 100 contacts


